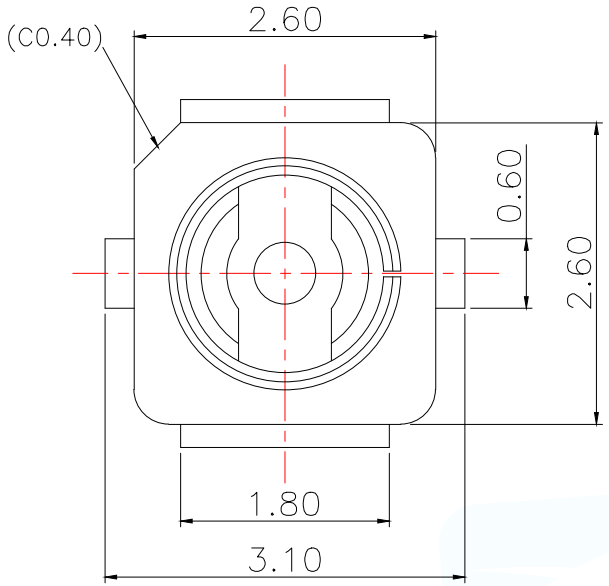
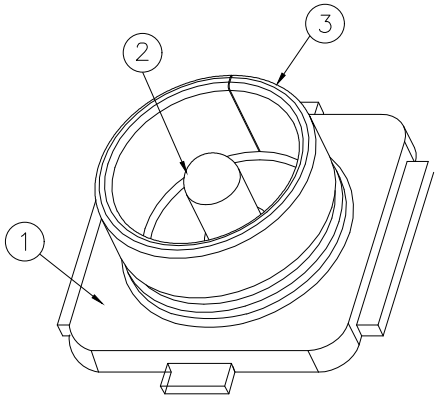
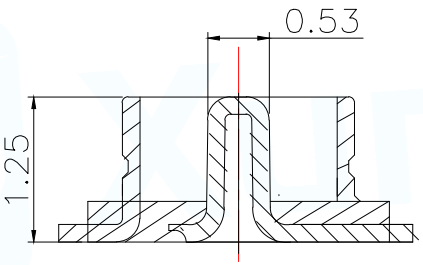
ROHS Compliant

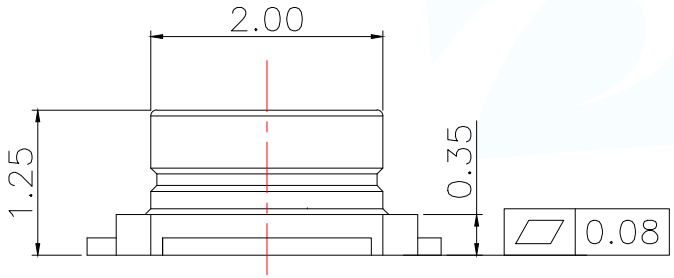
MAPX	MODIFICATION	DATE	DRAW	APPROVE

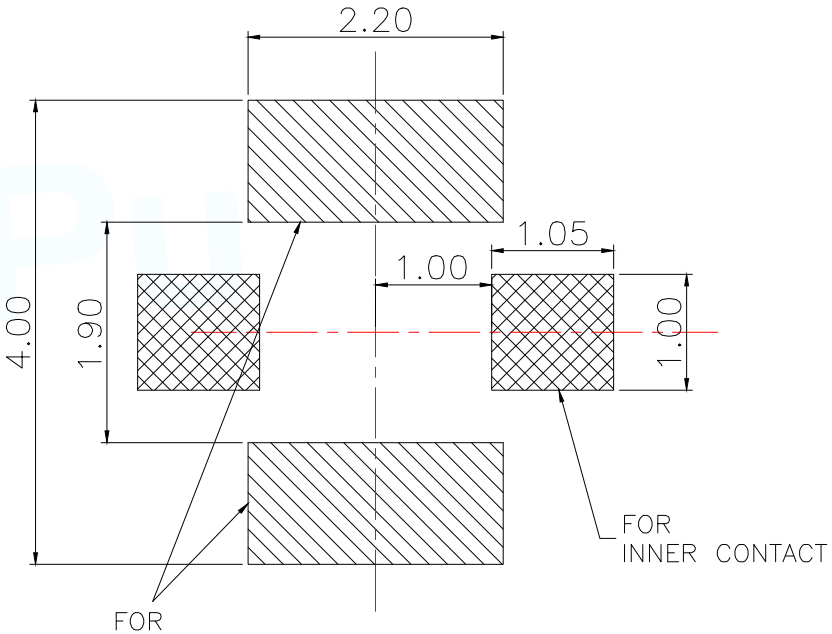


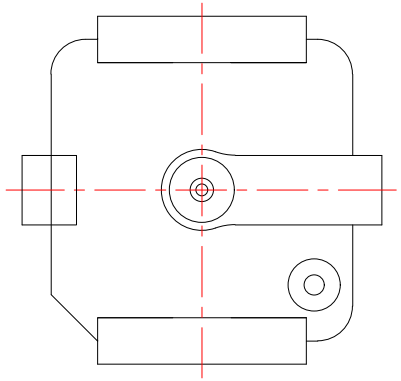


NOTE:1
1. ELECTRICAL CHARACTRRISTICS:
   1.1 CURRENT RATING: 0.5A MAX.
   1.2 IMPEDANCE:500HM NOMINAL.
2. MECHANICAL CHARACTERISTICS:
   2.1 OPERATING TEMP. −40°~90°
   2.2 VEWR UP TO 3GHz:1.3MAX.
   3GHz TO 6GHz:1.4MAX.
   2.3 DURABILITY:30CYCLES









NOTE:2
1.HOUSING MATERIAL: LCP, NATURE, UL94V−0.

2.TERMINAL MATERIAL: COPPER ALLOY (C2680),

3.SHELL MATERIAL: COPPER ALLOY (C5191),

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05

ITEM	DESCRIPTION	Q'TY	MATERIAL	FINISH	REMARK
3	GROUND CONTACT	1	COPPER ALLOY	Au PLATING OVER NI OVER ALL	
2	INNER CONTACT	1	COPPER ALLOY	Au PLATING OVER NI OVER ALL	
1	HOUSING	1	LCP UL94V−0		

MANUFACTURE DWG	东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co,Ltd
UNLESS OTHERWISE SPECIFED TOLERANCES	TITLE:RF BOARD END CONNECTOR,FIRST GENERATION
DECIMALS: .X:±0.25 .XX:±0.25 / ANGLES: .X°:±5° .XX°:±3° .XXX°:±1°	PAR: IPEX−001
	DWN: Lucas
	CHKD: Ethan
	APVD: Jacob
CUSTOMER COPY	SCALE1:1 UNIT:MM SIZE:A4 SHEET:1F1 REV:A

Unikeyic Electronics

Global Electronic Components Distributor

Click to view pricing, inventory, delivery, and lifecycle information:

XUNPU:

PCIE-52P40H WAFER-100L-3P WAFER-MX1.25B-10PWZ WAFER-MX1.25B-12PZZ WAFER-MX1.25B-2PZZ WAFER-MX3.0-14PWZ WAFER-PH2.0-2PJK DP-001-C-J DSHP-05-TJ-GER PH2.54-07-06PWD WAFER-MX1.25-4PWZ TF-123-ARP9H17 WAFER-XH2.54-5PZZ SMA-KE-347A-H13.5-P WAFER-PH2.0-4PZZ FPC-0.5HF-12PWBH20 FPC-0.5AX-8PWBH20 MCS-302S-C1 SIM-116-ACP7 TS-1009B-AR05026 WAFER-GH1.25-9PWB DSIC-01-LD-GET FPC-0.5AS-6PWBH20 WAFER-100W-4P WAFER-PH2.0-8PWZ WAFER-XH2.54-2PLB DSPV-02-LD-GET PHB2.0-02-24PWZ TS-1009-AR03826 WAFER-XH2.54-4PLB